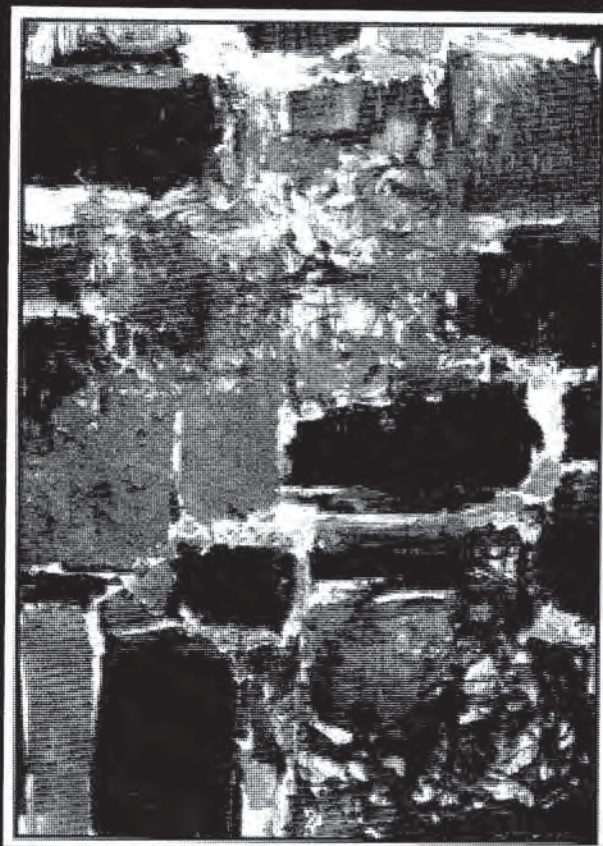


DIGITAL INTEGRATED CIRCUITS

A DESIGN PERSPECTIVE
SECOND EDITION



JAN M. RABAEY
ANANTHA CHANDRAKASAN
BORIVOJE NIKOLIĆ

PRENTICE HALL ELECTRONICS AND VLSI SERIES
CHARLES G. SODINI, SERIES EDITOR

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